



ESD



TVS



MOS



LDO



Diode



Sensor



DC-DC

Product Specification

| | |
|--------------------------|----------|
| ▶ Domestic Part Number | IRLL024Z |
| ▶ Overseas Part Number | IRLL024Z |
| ▶ Equivalent Part Number | IRLL024Z |



60V N-Channel Enhancement Mode MOSFET

General Description

- Trench Power MV MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low $R_{DS(ON)}$

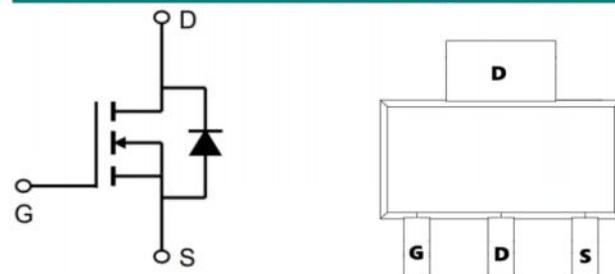
Applications

- DC-DC Converters
- Power management functions

Product Summary

- | | |
|------------------------------------|------------|
| • V_{DS} | 60V |
| • I_D | 3.0A |
| • $R_{DS(ON)}$ (at $V_{GS}=10V$) | < 80 mohm |
| • $R_{DS(ON)}$ (at $V_{GS}=4.5V$) | < 100 mohm |

SOT223-3L Pin Configuration



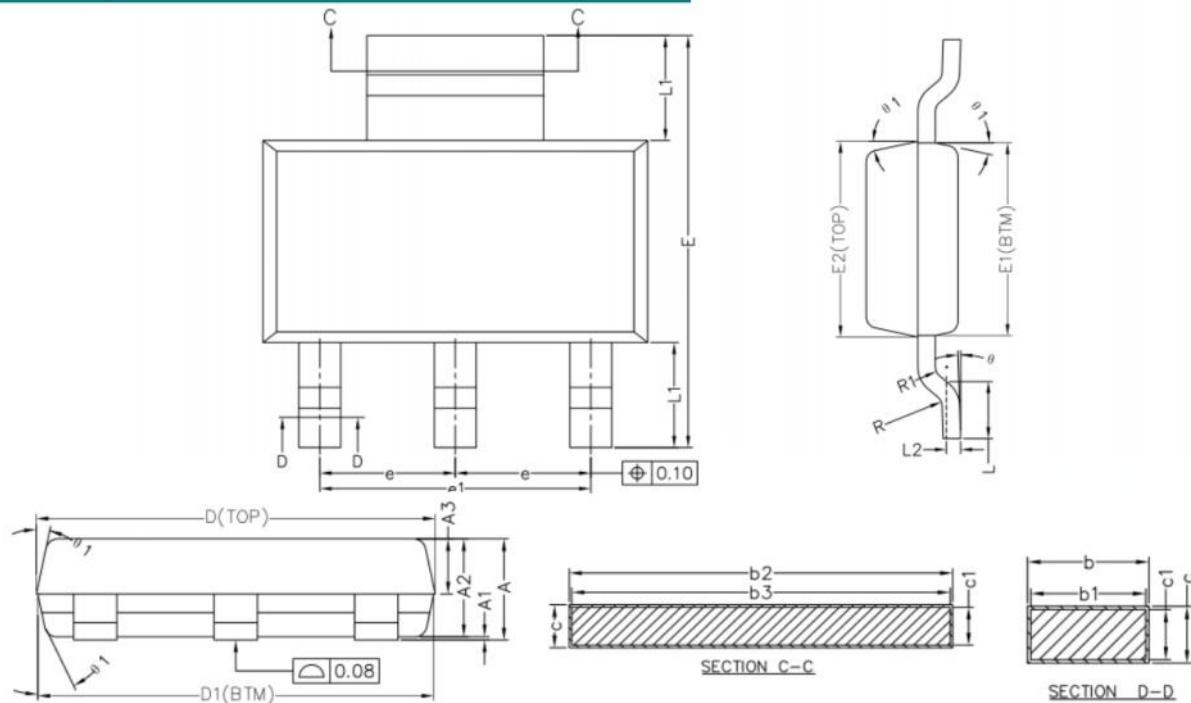
Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Limit | Unit |
|---|----------------|------------|--------------|
| Drain-source Voltage | V_{DS} | 60 | V |
| Gate-source Voltage | V_{GS} | ± 20 | V |
| Drain Current | I_D | 3.0 | A |
| Pulsed Drain Current ^A | I_{DM} | 12 | A |
| Total Power Dissipation @ $T_c=25^\circ C$ | P_D | 1.2 | W |
| Thermal Resistance Junction-to-Ambient ^B | R_{BJA} | 105 | $^\circ C/W$ |
| Junction and Storage Temperature Range | T_J, T_{STG} | -55 ~ +150 | $^\circ C$ |

60V N-Channel Enhancement Mode MOSFET
Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
|---------------------------------------|--------------------------|--|-----|-----|-----------|------------------|
| Static Parameter | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$ | 60 | | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}$ | | | 1 | μA |
| Gate-Body Leakage Current | I_{GSS1} | $V_{\text{GS}}= \pm 20\text{V}, V_{\text{DS}}=0\text{V}$ | | | ± 100 | nA |
| | I_{GSS2} | $V_{\text{GS}}= \pm 12\text{V}, V_{\text{DS}}=0\text{V}$ | | | ± 50 | nA |
| Gate Threshold Voltage | $V_{\text{GS(Th)}}$ | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$ | 1.1 | 1.7 | 2.3 | V |
| Static Drain-Source On-Resistance | $R_{\text{DS(ON)}}$ | $V_{\text{GS}}= 10\text{V}, I_{\text{D}}=2\text{A}$ | | | 80 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}= 4.5\text{V}, I_{\text{D}}=1.5\text{A}$ | | | 100 | |
| Diode Forward Voltage | V_{SD} | $I_{\text{S}}=2.0\text{A}, V_{\text{GS}}=0\text{V}$ | | 0.8 | 1.2 | V |
| Maximum Body-Diode Continuous Current | I_{S} | | | | 2.0 | A |
| Dynamic Parameters | | | | | | |
| Input Capacitance | C_{iss} | $V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$ | | 330 | | pF |
| Output Capacitance | C_{oss} | | | 90 | | |
| Reverse Transfer Capacitance | C_{rss} | | | 17 | | |
| Switching Parameters | | | | | | |
| Total Gate Charge | Q_{g} | $V_{\text{GS}}=10\text{V}, V_{\text{DS}}=30\text{V}, I_{\text{D}}=2.0\text{A}$ | | 5.1 | | nC |
| Gate-Source Charge | Q_{gs} | | | 1.3 | | |
| Gate-Drain Charge | Q_{gd} | | | 1.7 | | |
| Turn-on Delay Time | $t_{\text{D(on)}}$ | $V_{\text{GS}}=10\text{V}, V_{\text{DD}}=30\text{V}, I_{\text{D}}=1.5\text{A}, R_{\text{L}}=1\Omega, R_{\text{GEN}}=3\Omega$ | | 13 | | ns |
| Turn-on Rise Time | t_{r} | | | 51 | | |
| Turn-off Delay Time | $t_{\text{D(off)}}$ | | | 19 | | |
| Turn-off fall Time | t_{f} | | | 12 | | |

- A. Pulse Test: Pulse Width $\leq 300\text{us}$, Duty cycle $\leq 2\%$.
 B. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch.

60V N-Channel Enhancement Mode MOSFET
Package Mechanical Data-SOT-223


| Symbol | Min | Nom | Max |
|--------|------|---------|------|
| A | -- | -- | 1.80 |
| A1 | 0.02 | -- | 0.10 |
| A2 | 1.50 | 1.60 | 1.70 |
| A3 | 0.80 | 0.90 | 1.00 |
| b | 0.67 | -- | 0.80 |
| b1 | 0.66 | 0.71 | 0.76 |
| b2 | 2.96 | -- | 3.09 |
| b3 | 2.95 | 3.00 | 3.05 |
| C | 0.30 | -- | 0.35 |
| C1 | 0.29 | 0.30 | 0.31 |
| D | 6.48 | 6.53 | 6.58 |
| D1 | 6.55 | 6.60 | 6.65 |
| E | 6.80 | -- | 7.20 |
| E1 | 3.40 | 3.50 | 3.60 |
| E2 | 3.33 | 3.43 | 3.53 |
| e | | 2.30BSC | |
| e1 | | 4.60BSC | |
| L | 0.80 | 1.00 | 1.20 |
| L1 | | 1.75REF | |
| L2 | | 0.25BSC | |
| R | 0.10 | -- | -- |
| R1 | 0.10 | -- | -- |
| θ | 0° | -- | 8° |
| θ1 | 10° | 12° | 14° |

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